Polaronic Resistive Switching in Ceria-Based Memory Devices

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Resistive random access memory (RRAM), or memristors, operating with a voltage-controlled low- and high-resistance state (ON/OFF), are a critical component for next-generation nanoelectronics. Most memristors are based on oxides, but the underlying working mechanism remains generally unclear. Using first-principles calculations, it is revealed that it is polaron that acts as the conducting species to mediate the resistive switching process in CeO$_2$, while the commonly believed oxygen vacancy (V$_{O}^{2-}$) plays only a secondary role in assisting polaron formation. Importantly, polaron and related complexes have desired low formation energies (≈−0.3 eV) and extremely small migration barriers (≈0.1 eV), to synergistically form conductive filaments in the CeO$_2$ matrix with shallow electronic states near Fermi level, while V$_{O}^{2-}$ has a much higher migration energy and does not change the insulating nature of CeO$_2$. A switching field is also estimated of ≈3 V between the ON/OFF states from the relative stability of V$_{O}^{2+}$, H$_{int}$/H$_{sub}$(institutional/substitutional hydrogen) and polaron complexes in reference to Fermi level, which agrees with experiments. The proposed polaron-based switching mechanism is general, paving the way for future understanding and design of multifunctional electronic nanodevices beyond RRAM.

Resistive random access memory (RRAM) devices, also referred to as memristors, are passive two-terminal circuit elements that can retain internal resistive state based on the history of applied voltage. The device concept was first proposed by Chua in 1971,[1] and has attracted widespread attention since 1990s. Memristors possess advantages of nonvolatility, high scalability, fast reading/writing operation, high-density integration, and excellent endurance.[2–4] They hold great promise for future construction of electronic architectures that can circumvent the von Neumann bottleneck.[5] Recently tremendous efforts have been made to designing and fabricating novel RRAM nanodevices with enhanced performance.[6–12]

Typical memristor adopts a metal-insulator-metal (MIM) configuration, in which an insulator film is sandwiched between two metal electrode layers. The electrode materials can be active metals such as Ag, Cu, and Ni, or inert metals such as Pt, Au, Pd, W, and TaN.[6–8,10,12] For the insulator film, a wide variety of materials have been proposed, including but not limited to electrolytes, doped organic semiconductors, amorphous Si and C, oxides and nitrides.[12] In this context, transition metal oxides, including TiO$_2$,[13] ZnO,[14] Ta$_2$O$_5$,[15] NiO,[16] CoO,[17] perovskite oxides such as SrTiO$_3$,[4] Pr$_{0.7}$Ca$_{0.3}$MnO$_3$,[18] and Ba$_{0.7}$Sr$_{0.3}$TiO$_3$[19] and rare-earth oxides RE$_2$O$_3$ (RE = Y, Gd, Nd, Dy, Er)[20] have been most extensively explored for possible large-scale integrated circuits.

Cerium oxide (CeO$_2$) is a technologically important material with a broad range of applications in automotive exhaust, solid-oxide fuel cells and heterogeneous catalysts.[21–23] The presence of rich oxygen vacancies in CeO$_2$ endows it with exceptional oxygen storage and release capabilities. For these reasons, recent years have witnessed a surge of research pertaining to using CeO$_2$ as an insulating layer for memristive systems.[24–31] For instance, Hsieh et al.[24] reported RRAM in Al/CeO$_2$/Au with a low operating voltage and high resistance ratio, Kim[25] fabricated Pt/CeO$_2$/Pt device with resistance change >10$^5$ fold that mimics biological synaptic behaviors. Optimization of memristive performance has also been demonstrated by careful manipulation of oxygen vacancies via postannealing or doping of CeO$_2$.[26–28]

However, previous studies are all phenomenological in nature, and the physical mechanisms underlying RRAM are not clearly understood. Especially the creation/annihilation of conducting species responsible for the switching process remains unclear. A key challenge lies in the buried nature of conductive filament inside the oxide layer, which often involve sophisticated physical and chemical effects during switching between low-resistance (ON) and high-resistance (OFF) state. For MIM systems with active metal electrodes involving electrochemical
metallization (see Figure 1a), the active metal (M) is oxidized to metallic cations (M⁺) that migrate toward the inert cathode and become reduced to metal at the electrode surface. Consequently, a conductive filament composed of metal species forms to switch the system to ON state. On the other hand, for many memristors that are based on oxides, oxygen vacancies (V\textsubscript{O\textsubscript{2}}\textsuperscript{−}) are generally considered to be the dominant mobile species. It was suggested that migration of V\textsubscript{O\textsubscript{2}}\textsuperscript{−} toward the cathode turns one region of the oxide layer into a nonstoichiometric state (MO\textsubscript{1−x}, x = 0–1) forming a conductive filament to trigger the ON state (Figure 1b). However, as different defects usually exist in oxides, the exact mobile conducting species are difficult to be identified. Especially, formation and migration energies of V\textsubscript{O\textsubscript{2}}\textsuperscript{−} are expected to be high and a microscopic picture of transport process remains lacking.

Here, using CeO\textsubscript{2} as a prototypical system, we reveal the physical mechanisms underlying a polaron-mediated resistive switching process in RRAM devices, as shown in Figure 1c. It was proposed in some previous experiments\cite{28} that resistive switching effect in CeO\textsubscript{2} is based on migration of oxygen vacancies and polaron might also be involved. Surprisingly, we discover that in contrast with the common belief that oxygen vacancy forms the conductive filament, the CeO\textsubscript{2} with doubly ionized oxygen vacancy (V\textsubscript{O\textsubscript{2}}\textsuperscript{2−}) actually remains an insulating state so that V\textsubscript{O\textsubscript{2}}\textsuperscript{2−} cannot act as conducting species. Instead, polaron acts as the conducting species by inducing additional electronic states inside the energy gap of CeO\textsubscript{2}, and hence disentangling the electronic conductivity from ionic contribution.\cite{32–34} Most importantly, a low formation energy (≈0.3 eV) and an extremely small migration barrier (≈0.12 eV) renders synergistically a facile generation and migration of polarons to form the conductive filament in CeO\textsubscript{2} (Figure 1c). Furthermore, by comparing the formation energies of polaron and polaron complexes dressed with V\textsubscript{O\textsubscript{2}}\textsuperscript{3+}, interstitial and substitutional hydrogen (V\textsubscript{O\textsubscript{2}}\textsuperscript{1+}−polaron and H\textsubscript{m\textsuperscript{+}}/H\textsubscript{sub}−polaron) in reference to Fermi level, we are able to estimate a switching voltage of ≈3 V. These findings not only explain all the available experimental results\cite{24–31} but also shed new light on future design and fabrication of RRAM devices based on metal oxides with multivalence metal cations.

Bulk CeO\textsubscript{2} crystallizes in a cubic (fluorite) structure, which is an insulator with a wide bandgap of 3.3 eV.\cite{35} As previous studies\cite{36,37} suggested, screened hybrid functional is essential for correctly describing the energetic and electronic structures of CeO\textsubscript{2} and related systems. By using this sophisticated approach (computational details are shown in the Experimental Section), we calculated the orbital-projected density of states (DOS) of bulk CeO\textsubscript{2} (Figure 2a). The bandgap, between the occupied O 2p and unoccupied Ce 4f states, is 3.5 eV, in good agreement with the experimental value. We then evaluate the change in electronic structures of CeO\textsubscript{2} by introducing different defects. V\textsubscript{O\textsubscript{2}}\textsuperscript{2−} was generally accepted as the dominant conducting species for RRAM.\cite{6–9,12} However, based on the DOS presented in Figure 2b, CeO\textsubscript{2} remains an insulating state in the presence of V\textsubscript{O\textsubscript{2}}\textsuperscript{2−}, as the O 2p-Ce 4f gap decreases by only 0.3 eV. Because single Ce vacancy is difficult to form due to a large formation energy (>7.0 eV), a key issue then arises pertaining to the exact defect species responsible for the conductivity. Small polaron in the form of Ce\textsuperscript{4+} species represents an intrinsic defect in CeO\textsubscript{2}. It is characterized by electron localization in the 4f bands of Ce atoms accompanied by local structural distortion. As shown in Figure 2c, the polaron gives rise to a new occupied state located near the bottom of empty Ce 4f conduction band where the Fermi level resides. This signature strongly suggests that polaron can turn CeO\textsubscript{2} into a conductive state. Therefore, we propose that it is the small polaron, rather than oxygen vacancy, that acts as the conducting species to facilitate the switching process in RRAM devices.

Experiments have demonstrated the possibility of engineering resistive switching via controlled configurations and concentrations of oxygen vacancies.\cite{26,27} We suggest that although V\textsubscript{O\textsubscript{2}}\textsuperscript{2−} does not change the conductivity of CeO\textsubscript{2}, it can benefit the formation of polaron by donating electrons. Assuming each V\textsubscript{O\textsubscript{2}}\textsuperscript{2−} can bind with up to two polarons, forming singly positive (V\textsubscript{O\textsubscript{2}}\textsuperscript{2−}-polaron)* or neutral (V\textsubscript{O\textsubscript{2}}\textsuperscript{2−}-2polarons)\textsuperscript{0} complexes, we calculated the electronic structures of the two
complexes. DOS of \(V_{O_2}^{2\text{+}-1\text{polaron}}\) and \((V_{O_2}^{2\text{+}-2\text{polarons}})\) are shown in Figure 2d and Figure S1 in the Supporting Information, respectively, from which one can clearly see additional occupied states appeared near Fermi level, rendering \(\text{CeO}_2\) with good conductivity.

In practice, polarons can form with excess electrons contributed from both intrinsic defects, such as oxygen vacancies shown above, and also extrinsic charge donors present in the sample. Hydrogen is a common impurity in \(\text{CeO}_2\),\(^{[38]}\) which can be located at the interstitial site between O and Ce atoms, or a substituent replacing O. In both situations, H donates one electron to the system that tends to be localized close to nearby Ce atoms, favoring the formation of polaron. Indeed, our calculations show that interstitial H binds to the neighboring O atom with a bond length of \(\approx 1.0\ \text{Å}\), and polaron sits close to the interstitial H, resulting in a neutral \((\text{H}_{\text{int}}{^-}\text{-1polaron})\) complex (Figure 3a). The substitutional H turns the neighboring Ce atom into \(\text{Ce}^{3\text{+}}\) state, leading also to the formation of a neutral \((\text{H}_{\text{sub}}{^-}\text{-1polaron})\) complex (Figure 3b). We calculated the DOS for the two cases, both of which exhibit pronounced electronic states near Fermi level, indicating again good electronic conductivity. However, with pure \(\text{H}_{\text{int}}{^+}\) or \(\text{H}_{\text{sub}}{^+}\) (when one electron is taken away so that no polaron forms), the system is insulating (see Figure S2 in the Supporting Information) just like \(\text{CeO}_2\) with \(V_{O_2}^{2\text{+}}\). All the above calculation results suggest that polaron and/or polaron complexes are responsible for the desired conductive electronic structures. Experimentally, it has been shown that resistive switching could be effectively tuned by H doping in \(\text{TiO}_2\),\(^{[39]}\) which we think is also related to the polaronic effect we propose here due to the presence of H.

We have further considered intrinsic defect complexes of larger size by creating more \(V_{O_2}^{2\text{+}}\), so that more polarons can be introduced. In Figures S3 and S4 (Supporting Information), we show the detailed atomic configurations and partial DOS for \((2V_{O_2}^{2\text{+}-4\text{polarons}})\), \((3V_{O_2}^{2\text{+}-6\text{polarons}})\), \((4V_{O_2}^{2\text{+}-10\text{polarons}})\), and \((5V_{O_2}^{2\text{+}-10\text{polarons}})\) complexes. Our calculations indicate that these complexes tend to form complex clusters in \(\text{CeO}_2\). Interestingly, larger complexes tend to produce more pronounced electronic states with a broadened width near Fermi level, and hence making \(\text{CeO}_2\) more “metallic.”

Next, we address the energetic properties of polaron and the associated defect complexes. The stability can be evaluated by the polaron formation energy, \(E_{\text{form}}\), defined as the total energy difference between \(\text{CeO}_2\) in a polaronic state and a reference state with an extra electron delocalized in the narrow 4f band, i.e., \(E_{\text{form}} = E_{\text{tot}}(\text{polaron}) - E_{\text{tot}}(\text{delocalized})\). With this
definition, negative $E^{\text{form}}$ means that polaron is thermodynamically stable (exothermal). As listed in Table 1, the formation energy of a single polaron was calculated to be $-0.304$ eV, suggesting that electrons tend to be localized on Ce atom to form polaron. When a $V_O^{2+}$ is present, the formation energy of polaron decreases to $-0.362$ eV, which further decreases significantly to $-0.408$ eV with two polarons. This suggests that $V_O^{2+}$ enhances the formation of polarons in CeO$_2$, although $V_O^{2+}$ by itself does not contribute to the conductivity.

In the presence of H impurities, while $\text{H int}^{+}$ has negligible influence on the polaron formation energy, $\text{H sub}^{+}$ decreases the formation energy, and both can serve as the source of excess electron for the formation of polaron.

We have also calculated the formation energies of polaron complexes involving $V_O^{2+}$, $\text{H int}^{+}$, and $\text{H sub}^{+}$ as a function of Fermi energy, in order to assess the effects of possible doping and external electric field on their relative stability. Here, in a charging state of $q$, the formation energy can be written as:

$$E^{\text{form}}(X^q) = E_{\text{tot}}(X^q) - E_{\text{tot}}(\text{CeO}_2) + \mu(X) + q(E_{\text{Fermi}} + E_F) + \Delta^q$$

where $E_{\text{tot}}(X^q)$ is the total energy of the supercell containing a defect $X$ in a charging state $q$, and $E_{\text{tot}}(\text{CeO}_2)$ is the total energy of intrinsic CeO$_2$. The chemical potential $\mu(X)$ is the energy per atom of the defect reservoir, and $\mu_0(X)$ is the reference chemical potential. The Fermi level, which represents the energy of electronic reservoir, is a variable in this formalism in reference to the valence band maximum ($E_{\text{VBM}}$) of bulk CeO$_2$. Finally, $\Delta^q$ is the charging-state dependent correction due to the finite size of supercell. Figure 4 presents the calculated formation energies for $V_O^{2+}$, $\text{H int}^{+}$, $\text{H sub}^{+}$, $(V_O^{2+}-1\text{polaron})^0$, $(V_O^{2+}-2\text{polarons})^0$, $(\text{H int}^{+}-1\text{polaron})^0$, and $(\text{H sub}^{+}-1\text{polaron})^0$ complexes.
and (H_{int}^{+}-1polaron)$^0$ complexes. Clearly, under oxygen-poor condition ($\mu_o = -3.37$ eV), formation energies of $V_{O2}^{+}$ and polaron complexes are all much smaller than those under oxygen-rich condition ($\mu_o = 0$ eV). Over a large range of Fermi energy (0–3.0 eV), pure $V_{O2}^{+}$ is the most stable defect, indicating the insulating nature of CeO$_2$, which corresponds to the OFF state in resistive switching process. As Fermi energy increases, more polarons are formed and (V$_{O2}$)$^{+}$-2polarons)$^0$ complex becomes most stable when Fermi energy exceeds 3.1 eV (Figure 4a). As discussed above, CeO$_2$ with (V$_{O2}$)$^{+}$-1polaron)$^0$ or (V$_{O2}$)$^{+}$-2polarons)$^0$ are conductive, leading to an ON state. Similar behaviors were also found for CeO$_2$ with H impurities. As shown in Figure 4b, formation of H$_{sub}^{+}$ is energetically most stable (insulating, OFF) until Fermi energy exceeds 3.1 eV, where formation of (H$_{sub}^{+}$-1polaron)$^0$ prevails with a metallic feature, so that conductance emerges (ON). Therefore, the physical mechanism underlying the switching process in CeO$_2$ lies in the electric field controlled creation and annihilation of polarons in association with oxygen vacancies and/or H impurities, which decisively modulates the insulating/conducting nature of CeO$_2$. Remarkably, the calculated transition points of Fermi level for both $V_{O2}$-polaron and H-polaron complexes, ~3 eV, are in reasonable agreement with the experimentally reported switching voltages within a range of 2–4 V.$^{[24,26,27,31]}$ Despite that switching voltage is dependent on the dielectric thickness, fabrication process as well as electrode materials. We have thus far demonstrated the central role of polaron in modulating the electronic structures of CeO$_2$ and the stability of the polaron complex. Another key issue is its mobility in CeO$_2$, which dictates the kinetics of forming the conductive filament that determines the rate of switching process. To this end, we calculated the migration energy barriers of a single polaron and polaron in (V$_{O2}$)$^{+}$-1polaron)$^0$, (H$_{int}^{+}$-1polaron)$^0$, and (H$_{sub}^{+}$-1polaron)$^0$ complexes. As a comparison, we also calculated the migration barrier of V$_{O2}^{+}$ using the same model. Figure 5 shows the migration barriers as well as the atomic configuration at the saddle point. Specifically, the migration process involves a polaron moving from one Ce$_1^{3+}$ site to a neighboring Ce$_2^{4+}$ site, turning them into Ce$_1^{4+}$ and Ce$_2^{3+}$, respectively, i.e., Ce$_1^{3+}$-Ce$_2^{4+}$ $\rightarrow$ Ce$_1^{4+}$-Ce$_2^{3+}$. During this process, the excess electron is gradually transferred from Ce$_1$ to Ce$_2$ site, and the saddle point occurs at the middle point of initial and final configurations, where electrons are equally distributed between the two Ce atoms.

As shown in Figure 5, the migration barrier of a single polaron is 0.12 eV, which is very small, indicating a facile migration of polaron in CeO$_2$. In comparison, the migration barrier of single V$_{O2}^{+}$ is 0.47 eV, about four times larger than that of polaron. One can estimate their respective mobility $\mu$ at temperature $T$ by, $\mu \propto 1/T \exp \left(-E_a/k_B T \right)$, where $E_a$ is the activation energy (migration barrier) and $k_B$ is the Boltzmann constant. The mobility of polaron is found six orders of magnitude larger than that of V$_{O2}^{+}$ at room temperature (300 K). Remarkably, with the presence of V$_{O2}^{+}$, the migration barrier of polaron is further decreased to 0.07 by 0.05 eV relative to a single polaron (0.12 eV). Thus, oxygen vacancies greatly promote the migration of polarons. This implies an intriguing

![Figure 4](https://www.advancedsciencenews.com)

**Figure 4.** Calculated formation energies of a) $V_{O2}$-polaron complexes and b) H-polaron complexes in different charging states as a function of Fermi level. Solid and dashed lines denote the oxygen-rich and oxygen-poor condition, respectively.

![Figure 5](https://www.advancedsciencenews.com)

**Figure 5.** Migration profiles of single V$_{O2}^{+}$, polaron, polaron complexes with V$_{O2}^{+}$, H$_{int}^{+}$, and H$_{sub}^{+}$ in CeO$_2$, which are denoted by dark squares, red circles, blue diamonds, green regular triangles, and orange inverted triangles, respectively. Inset structures are the corresponding atomic configurations at the saddle point, superimposed with charge density isosurfaces for polaron (isovalue = 0.05 eÅ$^{-3}$).
The energetic and electronic structure calculations were performed in the framework of density functional theory, using the projector-augmented wave method with spin-polarization as implemented in the Vienna Ab Initio Simulation Package (VASP). The Ce (5s^25p^5d^4f^6s^2) and O (2s^22p^6) electrons were treated as valence states, and employed the screened hybrid functional of Heyd, Scuseria, and Ernzerhof (HSE06), which mixed 75% of the generalized gradient approximation in Perdew–Burke–Ernzerhof exchange and 25% of the nonlocal Hartree–Fock exchange. The screening parameter that separates the exchange potential into short and long range parts was set 0.2. To simulate V_{02} H impurity and polaron in CeO_2, a 2 × 2 × 2 supercell of CeO_2 was used. The equilibrium lattice parameters of CeO_2 was calculated to be 5.40 Å by HSE06, in good agreement with the experimental value of 5.41 Å.The integrations over the Brillouin zone of the supercell were performed using the (1/4, 1/4, 1/4) special-k point. A larger supercell of 3 × 3 × 3 was used to calculate the complexes of larger size. The energy cutoff for the plane-wave basis was set to 300 eV due to the high computational cost, and tests for the formation energy using a cutoff of 400 eV were also performed to ensure convergence. All structures were relaxed until the forces on each atom were lower than 0.01 eV Å\(^{-1}\).

**Supporting Information**

Supporting Information is available from the Wiley Online Library or from the author.

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**Conflict of Interest**

The authors declare no conflict of interest.

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